

Design Objectives

TE Solderless LED Socket, Type CM

DESIGN OBJECTIVES

The product described in this document has not been fully tested to ensure conformance to the requirements outlined below. Therefore, Tyco Electronics makes no representation or warranty, express or implied, that the product will comply with these requirements. Further, Tyco Electronics may change these requirements based on the results of additional testing and evaluation. Contact Tyco Electronics Engineering for further details.

1. SCOPE

1.1. Content

This specification covers performance, tests and quality requirements for Tyco Electronics Solderless LED Socket, Type CM designed for use with Cree XLamp MP-L LEDs.

1.2. Qualification

When tests are performed on the subject product line, procedures specified in Figure 1 shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

2. APPLICABLE DOCUMENTS

The following documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

- 2.1. Tyco Electronics Documents
 - 114-13281: Application Specification (Tyco Electronics (TE) Solderless LED Socket, Type CM)
 - 501-TBD: Qualification Test Report (TE Solderless LED Socket, Type CM)
- 2.2. Industry Document

EIA-364: Electrical Connector/Socket Test Procedures Including Environmental Classifications

2.3. Reference Document

109-197: Test Specification (Tyco Electronics Test Specifications vs EIA and IEC Test Methods)

3. **REQUIREMENTS**

3.1. Design and Construction

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2. Materials

Materials used in the construction of this product shall be as specified on the applicable product drawing.

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- 3.3. Ratings
 - Voltage: 30 volts DC
 - Current: 500 milliamperes
 - Temperature: -40 to 105°C
- 3.4. Performance and Test Description

Product is designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1. Unless otherwise specified, all tests shall be performed at ambient environmental conditions.

3.5. Test Requirements and Procedures Summary

Test Description	Requirement	Procedure	
Initial examination of product.	Meets requirements of product drawing and Application Specification 114-13281.	EIA-364-18. Visual and dimensional (C of C) inspection per product drawing.	
Final examination of product.	Meets visual requirements.	EIA-364-18. Visual inspection.	
	ELECTRICAL		
Low Level Contact Resistance (LLCR).	10 milliohms maximum initial. 25 milliohms maximum final.	EIA-364-23. Subject specimens to 100 milliamperes maximum and 20 millivolts maximum open circuit voltage. See Figure 3.	
Insulation resistance.	1 megohm minimum.	EIA-364-21. 500 volts DC, 2 minute hold. Test between adjacent contacts of mated specimens.	
Withstanding voltage.	One minute hold with no breakdown or flashover.	EIA-364-20, Condition I. 1070 volts DC at sea level. Test between adjacent contacts of mated specimens.	
Temperature rise vs current.	30°C maximum temperature rise at specified current.	EIA-364-70, Method 1. Stabilize at a single current level until 3 readings at 5 minute intervals are within 1°C. 100% of the circuits energized.	
	MECHANICAL		
Random vibration.	No discontinuities of 1 microsecond or longer duration. See Note.	EIA-364-28, Test Condition VII, Condition Letter D. Subject mated specimens to 3.10 G's rms between 20 to 500 Hz. Fifteen minutes in each of 3 mutually perpendicular planes. See Figure 4.	
	Figure 1 (continued)		

Figure 1 (continued)



Test Description	Requirement	Procedure	
Mechanical shock.	No discontinuities of 1 microsecond or longer duration. See Note.	EIA-364-27, Method H. Subject mated specimens to 30 G's half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction applied along 3 mutually perpendicular planes, 18 total shocks. See Figure 4.	
Durability.	See Note.	EIA-364-9. Mate and unmate specimens for 10 cycles at a maximum rate of 500 cycles per hour.	
Mating force.	40 N maximum.	EIA-364-13. Measure force necessary to mate specimens at a maximum rate of 12.7 mm per minute.	
Unmating force.	7 N minimum.	EIA-364-13. Measure force necessary to unmate specimens at a maximum rate of 12.7 mm per minute.	
	ENVIRONMENTAL	·	
Thermal shock.	See Note.	EIA-364-32, Test Condition VIII. Subject specimens to 25 cycles between -40 and 105°C with 30 minute dwells at temperature extremes and 1 minute transition between temperatures.	
Humidity/temperature cycling.	See Note.	EIA-364-31, Method III. Subject specimens to 10 cycles (10 days) between 25 and 65°C at 80 to 100% RH.	
Temperature life.	See Note.	EIA-364-17, Method A, Test Condition 4. Subject mated specimens to 105°C for 548 hours.	

NOTE

Shall meet visual requirements, show no physical damage, and meet requirements of additional tests as specified in the Product Qualification and Requalification Test Sequence shown in Figure 2.

Figure 1 (end)



	Test Group (a)		
Test or Examination	1	2	3
	Test Sequence (b)		e (b)
Initial examination of product	1	1	1
LLCR	3,7	2,5,7,9	
Insulation resistance			2,6
Withstanding voltage			3,7
Temperature rise vs current		3,10	
Random vibration	5	8	
Mechanical shock	6		
Durability	4		
Mating force	2		
Unmating force	8		
Thermal shock			4
Humidity/temperature cycling		4(c)	5
Temperature life		6	
Final examination of product	9	11	8

3.6. Product Qualification and Requalification Test Sequence

NOTE

See paragraph 4.1.A.

(a) (b) Numbers indicate sequence in which tests are performed.

(C) Precondition specimens with 5 durability cycles.

Figure 2



4. QUALITY ASSURANCE PROVISIONS

- 4.1. Qualification Testing
 - A. Specimen Selection

Specimens shall be prepared in accordance with applicable Instruction Sheets and shall be selected at random from current production. Each test group shall consist of a minimum of 5 specimens.

B. Test Sequence

Qualification inspection shall be verified by testing specimens as specified in Figure 2.

4.2. Requalification Testing

If changes significantly affecting form, fit or function are made to the product or manufacturing process, product assurance shall coordinate requalification testing, consisting of all or part of the original testing sequence as determined by development/product, quality and reliability engineering.

4.3. Acceptance

Acceptance is based on verification that the product meets the requirements of Figure 1. Failures attributed to equipment, test setup or operator deficiencies shall not disqualify the product. If product failure occurs, corrective action shall be taken and specimens resubmitted for qualification. Testing to confirm corrective action is required before resubmittal.

4.4. Quality Conformance Inspection

The applicable quality inspection plan shall specify the sampling acceptable quality level to be used. Dimensional and functional requirements shall be in accordance with the applicable product drawing and this specification.



TBD

Figure 3 LLCR Measurement Points

TBD

Figure 4 Vibration & Mechanical Shock Mounting Fixture